# SiHF15N65E

Vishay Siliconix

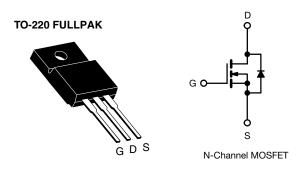
ROHS COMPLIANT

HALOGEN

FREE



# **E Series Power MOSFET**



PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700	)
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.28
Q <sub>g</sub> max. (nC)	96	
Q <sub>gs</sub> (nC)	11	
Q <sub>gd</sub> (nC)	21	
Configuration	Sing	le

### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and Halogen-free	SiHF15N65E-GE3

<b>ABSOLUTE MAXIMUM RATINGS (T</b> <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	650	v
Gate-Source Voltage V <sub>GS</sub> ± 30		± 30	v		
Continuous Drain Current (T <sub>1</sub> = 150 °C) $^{\circ}$	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1	15	
Continuous Drain Current (1) = 150°C)°	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	10	А
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	38	
Linear Derating Factor				0.27	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	286	mJ
Maximum Power Dissipation			PD	34	W
Operating Junction and Storage Temperature Range	e		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		al) / / alt	37	
Reverse Diode dV/dt <sup>d</sup>	-		dV/dt	23	V/ns
Soldering Recommendations (Peak temperature) <sup>c</sup>	For	10 s		300	°C
Mounting Torque	M3 s	screw		0.6	Nm

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 4.5$  A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C. e. Limited by maximum junction temperature.

S22-1001-Rev. D, 05-Dec-2022

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		65			°C ///	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		3.7			°C/W	
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}, I_D = 2$	250 µA	2	-	4	V
Onto Course Logicano	1	l I	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>	, N	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zaus Osta Malta sa Dusia Cumunt	1	V <sub>DS</sub> =	650 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 520 V	, V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$		<sub>D</sub> = 8 A	-	0.23	0.28	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub>	= 8 A	-	5.6	-	S
Dynamic						•		
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	1640	-		
Output Capacitance	C <sub>oss</sub>			-	80	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MHz		-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 520 V, V <sub>GS</sub> = 0 V		-	63	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$v_{\rm DS} = 0.0$	7 to 520 V,	v <sub>GS</sub> = 0 v	-	213	-	
Total Gate Charge	Qg				-	48	96	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8 A	, V <sub>DS</sub> = 520 V	-	11	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	21	-	1
Turn-On Delay Time	t <sub>d(on)</sub>				-	18	36	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 520 V, I <sub>D</sub>	= 8 A,	-	24	48	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	48	96	- ns	
Fall Time	t <sub>f</sub>			-	25	50		
Gate Input Resistance	R <sub>g</sub>	f = 1	MHz, ope	n drain	-	0.8	-	Ω
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol		-	-	15	_
Pulsed Diode Forward Current	I <sub>SM</sub>	integral revers p - n junction			-	-	38	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>.1</sub> = 25 °(	C, I <sub>S</sub> = 8 A.	$V_{GS} = 0 V$	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				-	325	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 2$	5 °C, I <sub>F</sub> = I 00 A/µs, V	S = 8 A,	-	4.6	-	μC
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 1	00 A/μs, V	<sub>R</sub> = 400 V	_	20	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

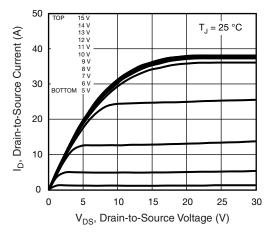


Fig. 1 - Typical Output Characteristics

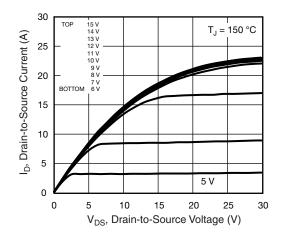


Fig. 2 - Typical Output Characteristics

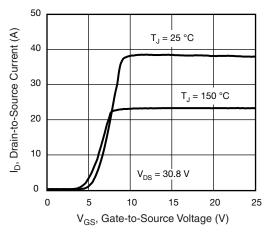


Fig. 3 - Typical Transfer Characteristics

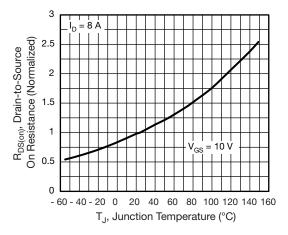


Fig. 4 - Normalized On-Resistance vs. Temperature

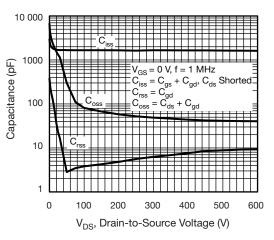


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

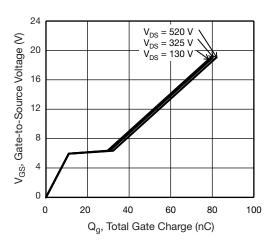


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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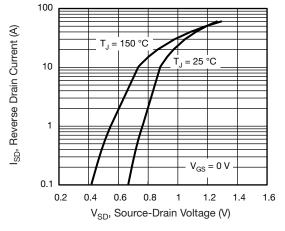
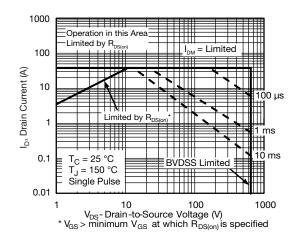


Fig. 7 - Typical Source-Drain Diode Forward Voltage





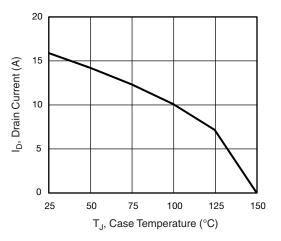


Fig. 9 - Maximum Drain Current vs. Case Temperature

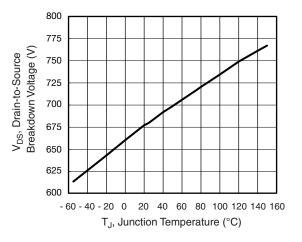


Fig. 10 - Temperature vs. Drain-to-Source Voltage

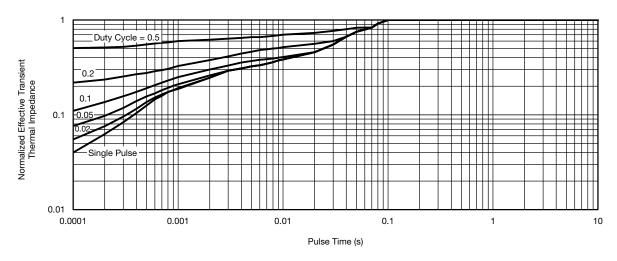


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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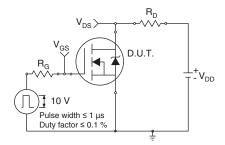


Fig. 12 - Switching Time Test Circuit

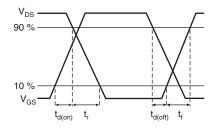


Fig. 13 - Switching Time Waveforms

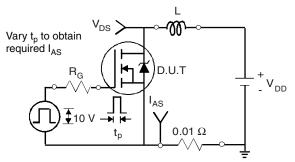


Fig. 14 - Unclamped Inductive Test Circuit

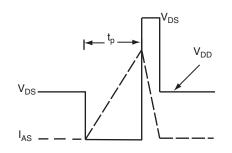


Fig. 15 - Unclamped Inductive Waveforms

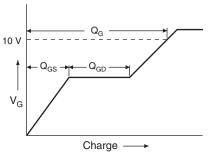


Fig. 16 - Basic Gate Charge Waveform

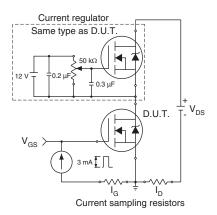


Fig. 17 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

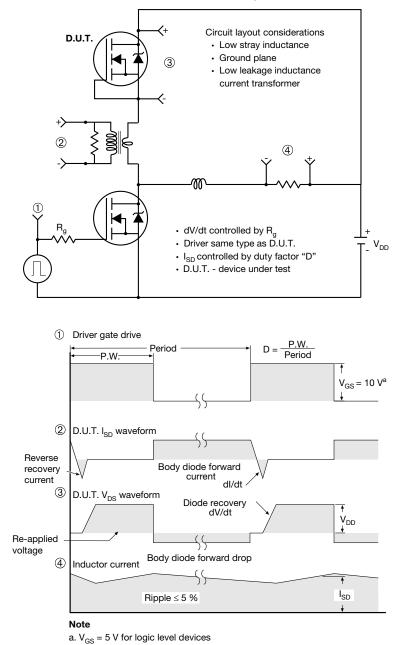


Fig. 18 - For N-Channel

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# **TO-220 FULLPAK (High Voltage)**

### **OPTION 1: FACILITY CODE = 9**



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

#### Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
  6. Facility code will be the 1<sup>st</sup> character located at the 2<sup>nd</sup> row of the unit marking

1



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### **OPTION 2: FACILITY CODE = Y**



MILLIMETERS		IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
E	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100	) BSC
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØP	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

DWG: 5972

#### Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet  $C_{pk} > 1.33$ 

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1<sup>st</sup> character located at the 2<sup>nd</sup> row of the unit marking

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